



[SEMI MEMS
and Imaging
Sensors
Summit
Highlight
New
Innovation
Opportunities
to Drive a
Sustainable
Future](#)

GRENOBLE, FRANCE — More than 40 experts will gather September 19-21 at the [SEMI MEMS & Imaging Sensors Summit](#) to share insights into new innovation opportunities for MEMS, imaging and sensors applications and their potential to enable a smarter and more sustainable world. [Registration](#) is open for the exhibition and conferences at the World Trade Center (WTC) in Grenoble, France.

Themed *Ubiquitous Sensing for A Sustainable World*, the summit will explore the latest MEMS, imaging and sensors technologies, developments and trends. The event is hosted by SEMI Europe and the [MEMS & Sensors Industry Group](#) (MSIG), a SEMI Technology Community.

“Rapid progress in the development and manufacture of MEMS and image sensors products featuring artificial intelligence (AI) and machine learning is leading a new wave of innovative applications,” said Laith Altimime, president of SEMI Europe. “We look forward to hosting industry thought leaders as they share their visions for how new advances promise to drive more eco-friendly products and applications.”

Featured Speakers at MEMS & Imaging Sensors Summit

Thought leaders will discuss MEMS and imaging sensors manufacturing advances and how the latest innovations are powering intelligent applications across sectors such as communications, mobility, IoT, entertainment and medical.



Hod Finkelstein, Head of
Cameras and
Depth, Reality Labs
[Meta](#)



Bernard Kress, Director,
Optical Engineering,
Augmented Reality
Hardware
[Google](#)



Lia Li, ZPM Co-founder
and CEO
[Zero Point Motion](#)



Kilian Bilger, Vice
President Engineering
Sensor Components
[Bosch](#)



Theodor Nielsen, CEO
[NIL Technology \(NILT\)](#)



Isabella Drolz, Vice
President of Product
Marketing [Comet Yxlon](#)



Moti Margalit, CEO
[SonicEdge](#)





Martin Croome, Vice
President of
Marketing [GreenWaves
Technologies](#)



Julia Brueckner,
Global Applications &
Product Engineering
Manager for Packaging &
Wafer
Business Unit
[Corning Incorporated](#)



Gala Dinner and Networking Opportunities

The SEMI MEMS & Imaging Sensors Summit will feature networking opportunities including a complimentary welcome reception on September 19 in the exhibition area at the WTC and a gala dinner on September 20. [Registration](#) for the gala dinner at the [Chateau de Sassenage](#) is open.

[Industry Leaders](#) Exhibiting at MEMS & Imaging Sensors Summit

- Adeia
- AEMtec
- Besi
- Comet Yxlon
- Eurofins | MASER
- EV Group (EVG)
- FormFactor
- OPTIM Wafer Services
- Philips MEMS & Micro Devices
- Polytechnik AS
- ProSys
- Pyxalis
- SET Corporation
- Siconnex
- Siemens EDA (represented by EDA Solutions Limited)
- Sumitomo Precision Products
- SUSS Microtec
- W. L. Gore & Associates

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For more information, please visit the [SEMI MEMS & Imaging Sensors Summit](#) website.

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